



NCE N-Channel Enhancement Mode Power MOSFET

Description

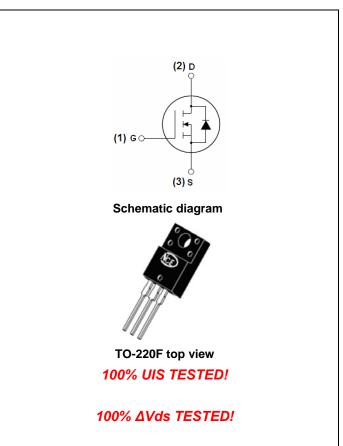
The NCE0224AF uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- $V_{DS} = 200V, I_D = 24A$ $R_{DS(ON)} < 80m\Omega @ V_{GS} = 10V$ (Typ:62m Ω)
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high EAS
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE0224AF	NCE0224AF	TO-220F	-	-	-

Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	200	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι _D	24	А
Drain Current-Continuous(Tc=100℃)	l _D (100℃)	16.5	А
Pulsed Drain Current	I _{DM}	100	А
Maximum Power Dissipation	PD	45	W
Single pulse avalanche energy (Note 5)	E _{AS}	250	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ extsf{ heta}JA}$	3.33	°C/W





Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	200	220	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =200V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	1.0	1.5	2.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =15A	-	62	80	mΩ
Forward Transconductance	g fs	V _{DS} =10V,I _D =15A	30	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}			4200		PF
Output Capacitance	C _{oss}	$V_{DS}=25V, V_{GS}=0V,$		163		PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz		75		PF
Switching Characteristics (Note 4)			•			
Turn-on Delay Time	t _{d(on)}		-	10	-	nS
Turn-on Rise Time	tr	V _{DD} =100V,I _D =15A	-	18	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{GEN} =2.5 Ω	-	22	-	nS
Turn-Off Fall Time	t _f		-	5	-	nS
Total Gate Charge	Qg			60		nC
Gate-Source Charge	Q _{gs}	V_{DS} =100V,I _D =15A,		19		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V		17		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =15A	-	-	1.2	V
Diode Forward Current (Note 2)	I _S			-	24	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 15A	-	90	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	300	-	nC

Notes:

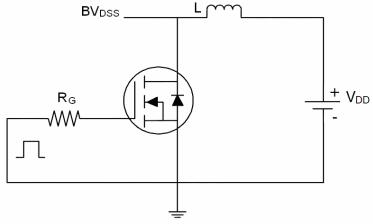
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, t \leq 10 sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition: Tj=25 $^\circ \! \mathbb{C}, V_{DD} \! = \! 50V, V_G \! = \! 10V, L \! = \! 0.5mH, Rg \! = \! 25\Omega$



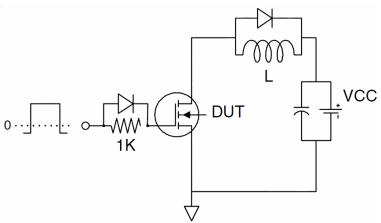
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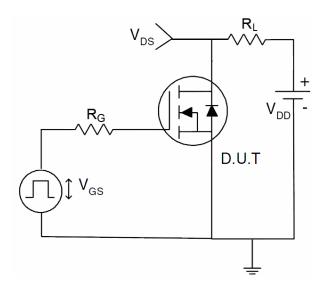
Test Circuit 1) E_{AS} Test Circuits



2) Gate Charge Test Circuit



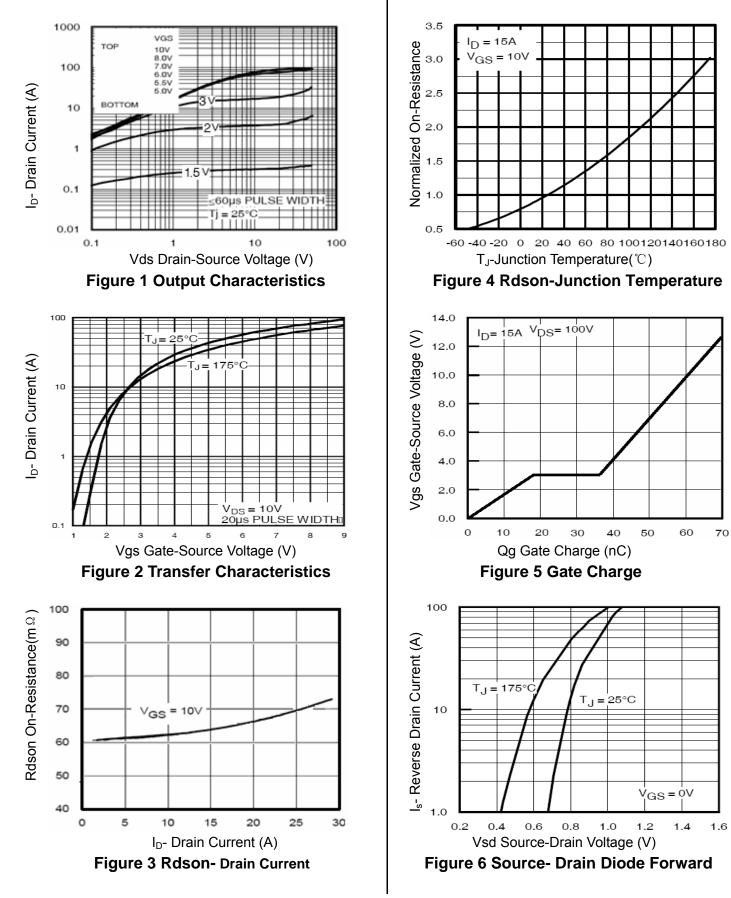
3) Switch Time Test Circuit







Typical Electrical and Thermal Characteristics (Curves)





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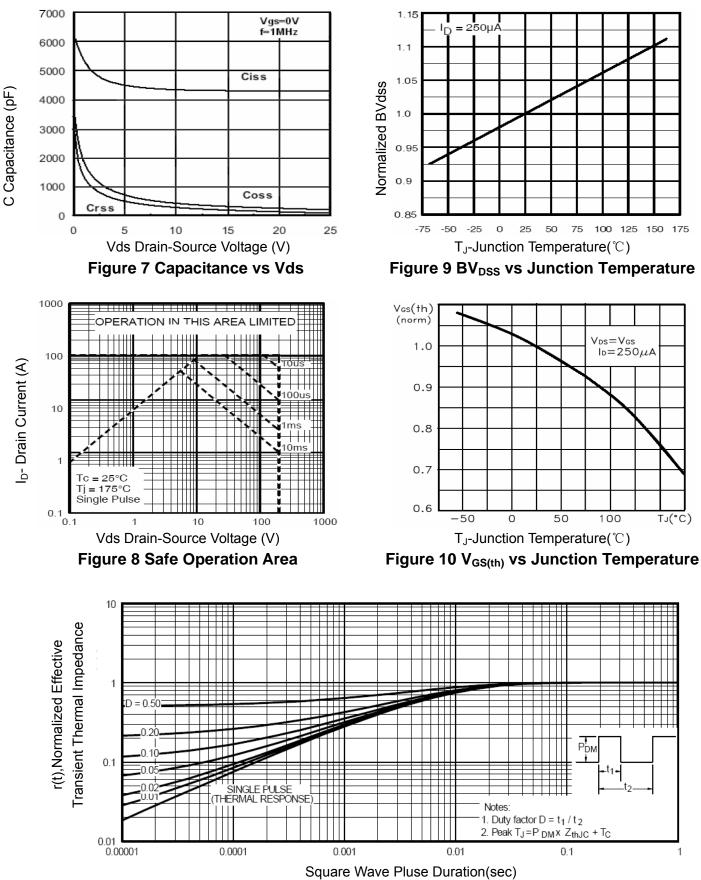
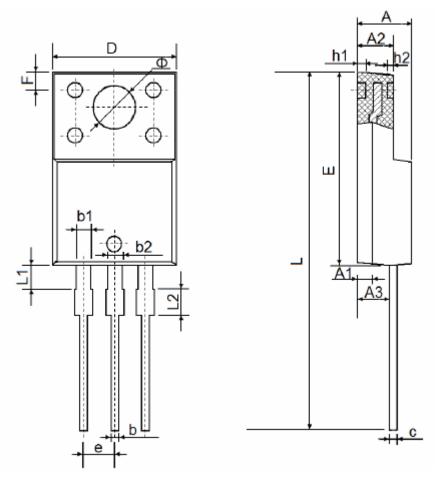


Figure 11 Normalized Maximum Transient Thermal Impedance





TO-220F Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches			
Symbol	Min.	Max.	Min.	Max.		
А	4.300	4.700	0.169	0.185		
A1	1.30	0REF	0.051	IREF		
A2	2.800	3.200	0.110	0.126		
A3	2.500	2.900	0.098	0.114		
b	0.500	0.750	0.020	0.030		
b1	1.100	1.350	0.043	0.053		
b2	1.500	1.750	0.059	0.069		
с	0.500	0.750	0.020	0.030		
D	9.960	10.360	0.392	0.408		
E	14.800	15.200	0.583	0.598		
e	2.540	DTYP.	0.100TYP			
F	2.70	REF 0.106REF		REF		
Φ	3.50	3.500REF		0.138REF		
h1	0.800REF		0.031REF			
h2	0.500REF		0.020REF			
L	28.000	28.400	1.102	1.118		
L1	1.700	1.900	0.067	0.075		
L2	1.900	2.100	0.075	0.083		





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